



## P-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)		
- 12	$0.016 \text{ at V}_{GS} = -4.5 \text{ V}$	- 13		
	$0.022 \text{ at V}_{GS} = -2.5 \text{ V}$	- 11		
	$0.028$ at $V_{GS} = -1.8 \text{ V}$	- 9.8		

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFETS: 1.8-V Rated
- New PowerPAK<sup>®</sup> Package
  - Low Thermal Resistance, R<sub>thJC</sub>
  - Low 1.07-mm Profile

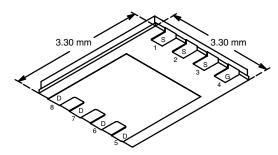


RoHS\*

#### **APPLICATIONS**

- · Load Switch
- Power Switch
- PA Switch

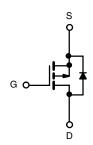
#### PowerPAK 1212-8



Bottom View

Ordering Information: Si7405DN-T1

Si7405DN-T1-E3 (Lead (Pb)-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T <sub>A</sub> = 25 °C,	unless otherwi	se noted		
Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		$V_{DS}$	- 12		V
Gate-Source Voltage		V <sub>GS</sub>	± 8		
Continuous Drain Current (T <sub>.I</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 25 °C		– 13	- 8.3	
Continuous Diain Current (1) = 150°C)	T <sub>A</sub> = 85 °C		- 9.4	- 6.0	•
Pulsed Drain Current		I <sub>DM</sub>	- 30		Α
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	- 3.2	- 1.3	
Maniana Dama Diasinational	T <sub>A</sub> = 25 °C		3.8	1.5	W
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 85 °C		2.0	0.8	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C
Soldering Recommendations <sup>b,c</sup>			260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 10 sec	- R <sub>thJA</sub>	26	33	
	Steady State		65	81	°C/W
Maximum Junction-to-Case	Steady State		1.9	2.4	

#### Notes

a. Surface Mounted on 1" x 1" FR4 Board.

b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

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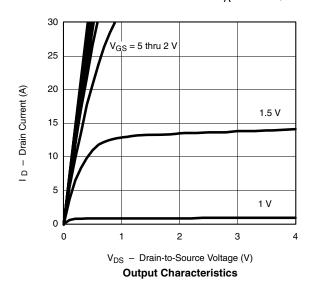
Parameter	Symbol Test Condition Min			lin Typ	Max	Unit	
Static				, ,, , , , , , , , , , , , , , , , , ,			
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -2 \text{ mA}$	- 0.45		- 1.0	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 12 V, V <sub>GS</sub> = 0 V		- 1	4		
		$V_{DS} = -12 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			- 5	μA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 30			Α	
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -13 \text{ A}$		0.013	0.016	Ω	
		$V_{GS} = -2.5 \text{ V}, I_D = -11 \text{ A}$		0.018	0.022		
		$V_{GS} = -1.8 \text{ V}, I_D = -3 \text{ A}$		0.022	0.028	ı	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -6 \text{ V}, I_D = -13 \text{ A}$		35		S	
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = -3.2 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.7	- 1.2	V	
Dynamic <sup>b</sup>							
Total Gate Charge	$Q_g$			35	50		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -13 \text{ A}$		6.6		nC	
Gate-Drain Charge	$Q_{gd}$			7.7			
Turn-On Delay Time	t <sub>d(on)</sub>			25	40		
Rise Time	t <sub>r</sub>	$V_{DD} = -6 \text{ V}, R_L = 6 \Omega$		50	75		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D\cong$ - 1 A, $V_{GEN}$ = - 4.5 V, $R_G$ = 6 $\Omega$		175	260	ns	
Fall Time	t <sub>f</sub>			150	225		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	$I_F = -3.2 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		30	60		

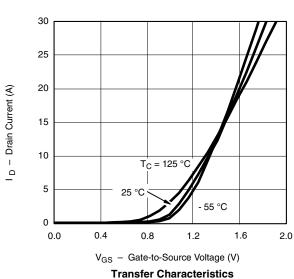
#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **TYPICAL CHARACTERISTICS** $T_A = 25 \, ^{\circ}C$ , unless otherwise noted



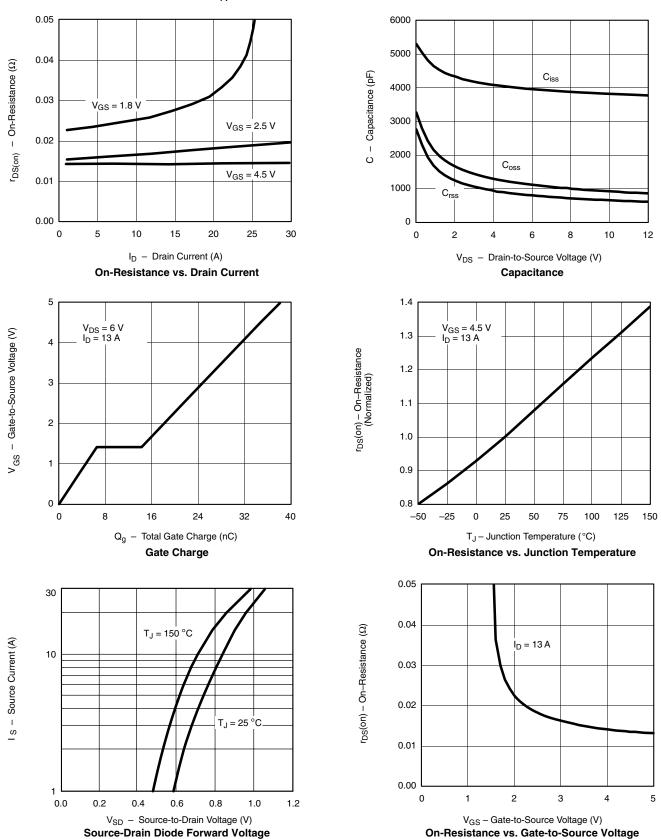








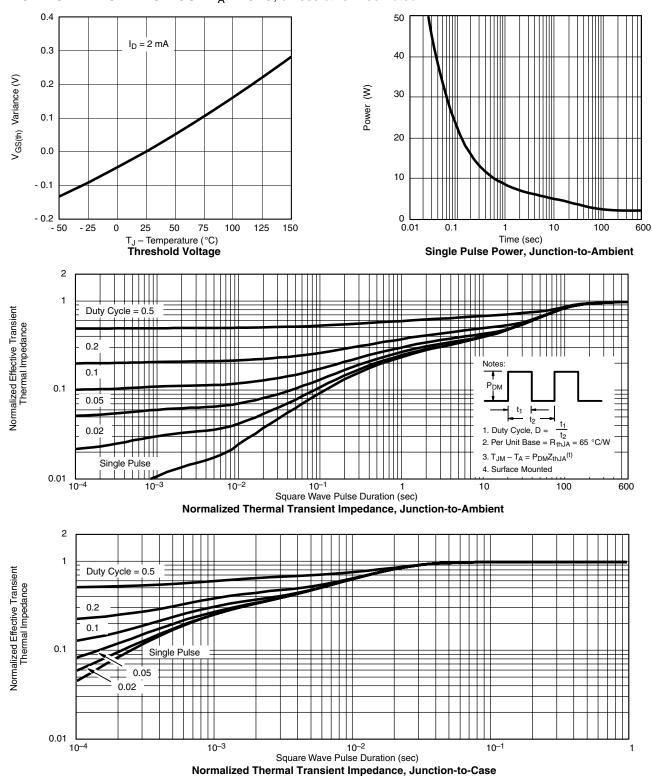
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